

Z-PACK | Z-PACK 2mm HM

TE Internal #: 100147-1

Hard Metric Backplane PCB Mount Receptacle, ≤1 Gb/s, 22

Column, 5 Row, Mezzanine, 110 Position, 2 mm [.078 in] Centerline,

Right Angle, Z-PACK 2mm HM

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HM Receptacle Connector: Traditional Backplane, Coplanar, 2mm











PCB Connector Assembly Type: PCB Mount Receptacle

Data Rate: ≤1 Gb/s
Number of Columns: 22

Number of Rows: 5

Backplane Architecture: Mezzanine

All HM Receptacle Connector: Traditional Backplane, Coplanar, 2mm (48)

Features

Industry Standards

Termination Features

Termination Method to PCB	Through Hole - Press-Fit
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Mechanical Attachment

Connector Mounting Type	Board Mount
Mating Alignment Type	Multi-Purpose Center

Dimensions

Backplane Module Length	50 mm	

Operation/Application

Shielded	No
Circuit Application	Power & Signal



Contact Features

Contact Mating Area Length Contact Mating Area Length Contact Base Material Contact Base Material CompactPCI Designation PCB Contact Termination Area Plating Material Feedthrough Post Length Contact Type Socket Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material Thickness T/6 µm(30 µin) Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) Configuration Features Rows Loaded B, C, D, F, A Number of Columns 22 Number of Rows Seakplane Architecture Mezzanine Number of Positions PCB Mount Orientation Signal Characteristics Crosstalk Version Standard		
Contact Base Material Phosphor Bronze CompactPCI Designation None PCB Contact Termination Area Plating Material Tin-Lead Feedthrough Post Length 3.3 mm Contact Type Socket Contact Mating Area Plating Material Gold Contact Mating Area Plating Material Thickness ./6 µm[30 µin] Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Contact Underplating Material	Nickel
CompactPCI Designation None PCB Contact Termination Area Plating Material Tin-Lead Feedthrough Post Length 3.3 mm Contact Type Socket Contact Mating Area Plating Material Gold Contact Mating Area Plating Material Thickness .76 µm[30 µin] Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Contact Mating Area Length	3.7 mm
PCB Contact Termination Area Plating Material Feedthrough Post Length Contact Type Socket Contact Mating Area Plating Material Contact Mating Area Plating Material Thickness Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity Packaging Method Housing Features Housing Material PBT GF Centerline (Pitch) Packagine (Pitch) Pofiguration Features Rows Loaded Rows Backplane Architecture Number of Positions PCB Mount Orientation Right Angle Signal Characteristics	Contact Base Material	Phosphor Bronze
Feedthrough Post Length Contact Type Socket Contact Mating Area Plating Material Gold Contact Mating Area Plating Material Thickness .76 µm[30 µin] Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	CompactPCI Designation	None
Contact Type Contact Mating Area Plating Material Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material Thickness Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	PCB Contact Termination Area Plating Material	Tin-Lead
Contact Mating Area Plating Material Contact Mating Area Plating Material Thickness .76 µm[30 µin] Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Feedthrough Post Length	3.3 mm
Contact Mating Area Plating Material Thickness .76 µm[30 µin] Contact Current Rating (Max) 1.5 A Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Contact Type	Socket
Contact Current Rating (Max) Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows Backplane Architecture Number of Positions 110 PCB Mount Orientation Signal Characteristics	Contact Mating Area Plating Material	Gold
Packaging Features Packaging Quantity 11 Packaging Method Tube Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Packaging Quantity Packaging Method Housing Features Housing Material Centerline (Pitch) Configuration Features Rows Loaded Rows Loaded Number of Columns 22 Number of Rows Backplane Architecture Number of Positions 110 PCB Mount Orientation Signal Characteristics	Contact Current Rating (Max)	1.5 A
Packaging Method Housing Features Housing Material Centerline (Pitch) PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Packaging Features	
Housing Features Housing Material PBT GF Centerline (Pitch) 2 mm[.078 in] Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Packaging Quantity	11
Housing Material Centerline (Pitch) Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Packaging Method	Tube
Centerline (Pitch) Configuration Features Rows Loaded Rows Loaded	Housing Features	
Configuration Features Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Housing Material	PBT GF
Rows Loaded B, C, D, E, A Number of Columns 22 Number of Rows 5 Backplane Architecture Mezzanine Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Centerline (Pitch)	2 mm[.078 in]
Number of Columns22Number of Rows5Backplane ArchitectureMezzanineNumber of Positions110PCB Mount OrientationRight AngleSignal Characteristics	Configuration Features	
Number of Rows5Backplane ArchitectureMezzanineNumber of Positions110PCB Mount OrientationRight AngleSignal Characteristics	Rows Loaded	B, C, D, E, A
Backplane Architecture Number of Positions 110 PCB Mount Orientation Right Angle Signal Characteristics	Number of Columns	22
Number of Positions PCB Mount Orientation Right Angle Signal Characteristics	Number of Rows	5
PCB Mount Orientation Right Angle Signal Characteristics	Backplane Architecture	Mezzanine
Signal Characteristics	Number of Positions	110
	PCB Mount Orientation	Right Angle
Crosstalk Version Standard	Signal Characteristics	
	Crosstalk Version	Standard
Data Rate ≤1 Gb/s	Data Rate	≤1 Gb/s

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Backplane Interface Type	2mm HM
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Receptacle



Sealable	No
Body Features	
Primary Product Color	Gray
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Other	
EU RoHS Compliance	Not Compliant
EU ELV Compliance	Compliant with Exemptions

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

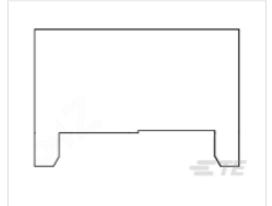




TE Part # 646478-2 2MM H.M., "A" SHROUD, 3.9MM



TE Part # 646478-5 2MM H.M., "A" SHROUD, 4.5MM



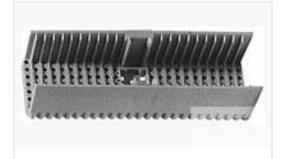
TE Part # 122559-1 SEATING TOOL 2MM HM 7 ROW



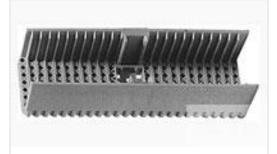
TE Part # 646478-6 2MM H.M., "A" SHROUD, 4.7MM



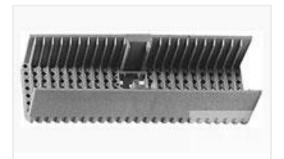
TE Part # CAT-472-Z12
Hard Metric Male Connector:
Traditional Backplane, Mezzanine,
2mm



TE Part # 646478-7 2MM H.M., "A" SHROUD, 4.9MM



TE Part # 646478-1 2MM H.M., "A" SHROUD, 3MM



TE Part # 646478-4 2MM H.M., "A" SHROUD, 4.3MM

Also in the Series Z-PACK 2mm HM



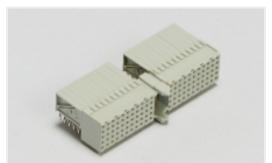
Board-to-Board Headers & Receptacles(46)



Connector Contacts(2



Connector Hardware(91)



Hard Metric Backplane Connectors (267)



High Speed Backplane Connectors(1)

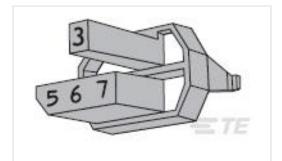


Power Contacts(2)

Customers Also Bought



TE Part #5207908-4 STRAIN REL W/SCREW RET KIT



TE Part #3-100526-2 Z-PACK F.CODING KEY



TE Part #204504-1
RECEPT ASSY,SZ 3,AMPLIMITE



TE Part #103308-2 014 LOPRO HDR SP 15DP















Documents

Product Drawings

Z-PACK/A F-HDR.110P

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_100147-1_N.2d_dxf.zip

English

Customer View Model

ENG_CVM_100147-1_N.3d_igs.zip

English

Customer View Model

ENG_CVM_100147-1_N.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Instruction Sheets

INSERTION TOOL FOR Z-PACK 2mm HM CONN.

Japanese

Instruction Sheet (non U.S.)

Japanese

Hard Metric Backplane PCB Mount Receptacle, ≤1 Gb/s, 22 Column, 5 Row, Mezzanine, 110 Position, 2 mm [.078 in] Centerline, Right Angle, Z-PACK 2mm HM

